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PRODUCT RELIABILITY REPORT FOR

DS2155, Rev C2

Maxim Integrated Products

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

Don Lipps Staff Reliability Engineer Maxim Integrated Products 4401 South Beltwood Pkwy. Dallas, TX 75244-3292 Email: don.lipps@maxim-ic.com ph: 972-371-3739 fax: 972-371-6016

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

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DS2155, Rev C2
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In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts AfT = Acceleration factor due to Temperature tu = Time at use temperature (e.g. 55°C) ts = Time at stress temperature (e.g. 125°C) k = Boltzmann's Constant (8.617 x 10-5 eV/°K) Tu = Temperature at Use (°K) Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu)) AfV = Acceleration factor due to Voltage Vs = Stress Voltage (e.g. 7.0 volts) Vu = Maximum Operating Voltage (e.g. 5.5 volts) B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)X = Chi-Sq statistical upper limit N = Life test sample size Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE:	MTTF (YRS):	73515	FITS:	1.6
	DEVICE HOURS:	625640	FAILS:	0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 T	u: 25	°C	Vu: 3.5	Volts
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The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "*" after DATE CODE denotes specific product data and SEQ No. to identify specific line items in the report for comments when required.

Device Information:	
Process:	2P, 4M,0.35um,Sil.P1,P2Cap,Ti/TiN M1-M4,BPSG,Masked N+ESD,
Passivation:	Passivation w/Nov TEOS Oxide-Nitride
Die Size:	222 x 259
Number of Transistors:	765000
Interconnect:	Aluminum / 0.5% Copper
Gate Oxide Thickness:	75 Å

ELECTRICAL CHARACTERIZATION

DESCRIPTION	DATE CODE/SEQ		CONDITION		READPOINT		FAILS	FA#
ESD SENSITIVITY	0618	* 1	EOS/ESD S5.1 HBM 500 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0618	* 2	EOS/ESD S5.1 HBM 1000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0618	* 3	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0618	* 4	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0618	* 5	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	2	No FA
LATCH-UP	0618	* 6	JESD78, I-TEST 125C			6	0	
LATCH-UP	0618	* 7	JESD78, V-SUPPLY TEST 125C			6	0	
					Total:		2	

OPERATING LIFE

DESCRIPTION	DATE CODE/SEQ	CONDITION	READ	POINT	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0542	125C, 3.5 VOLTS	192	HRS	45	0	
HIGH TEMP OP LIFE	0604	125C, 3.5 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0617	125C, 3.6 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0617	125C, 3.6 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0617	125C, 3.6 VOLTS	1000	HRS	45	0	

	DE	EVICE HC	URS:	625640	FAILS:		0		
FAILURE RATE:		MTTF (YRS):	73515	FITS:		1.6		
						-	Fotal:		0
HIGH TEMP OP LIFE	0811	125C, 3.5 VOLTS				1000	HRS	45	0
HIGH TEMP OP LIFE	0716		OLTS		1000	HRS	45	0	
HIGH TEMP OP LIFE	0650			1000	HRS	45	0		
HIGH TEMP OP LIFE	0650 125C, 3.5 VOLTS					1000	HRS	45	0
HIGH TEMP OP LIFE	0641 125C, 3.5 VOLTS					1000	HRS	45	0
HIGH TEMP OP LIFE	0632 125C, 3.5 VOLTS					1000	HRS	45	0
HIGH TEMP OP LIFE	0632		125C, 3.5 V	125C, 3.5 VOLTS			HRS	45	0
HIGH TEMP OP LIFE	0620		125C, 3.5 VOLTS			1000	HRS	45	0
HIGH TEMP OP LIFE	0618	* 1	125C, 3.5 VOLTS			1000	HRS	77	0